



## Features:

- 6 oz. spool
- Rosin flux core
- Diameter: 1mm (0.04")
- Melting point: 227° C (441° F)
- 99.3% tin, 0.7% copper
- · Also available in 1 lb. spools, see Item #21-1041

## **Description:**

## Lead–Free Solder

Ideal for general purpose electronic repair and assembly use. Tin/copper formulation meets current requirements for lead free solder use.

## Part Number Table

Description	Part Number
Lead Free Rosin Core Solder - Tin / Copper - 6oz	21-1046

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